





1 2 3 PRODUCT NO. DIAGRAM #1 DIAGRAM #2 DIAGRAM #3 DIAGRAM #4 SEE TABLE GROUND SPRING CODE Z CONFIGURATIONS DIAGRAM #1 DIAGRAM #2 PRODUCT NO. DIAGRAM #3 DIAGRAM #4 72231-X8YZLF GROUND SPRING CONFIGURATIONS AS VIEWED FROM PORT SIDE NOTE:PLEASE CHECK FOR AVAILABILITY.NOT ALL OPTIONS AVAILABLE. OPTIONAL LOADING **POSITIONS** R .25 [0.010] MAX-16.66 [0.656] -CODE Y LOADED -8 POSITION 3,4,5,6 HOUSING



12.29 [0.484]

10 [0.004]

TOP OF PCB TO BOTTOM OF OPENING

RECOMMENDED PANEL OPENING

NOTES:

- 1. RECOMMENDED P.C.B. THICKNESS 1.60 [0.063].
- HOUSING MATL: HIGH TEMPERATURE THERMOPLASTIC MATERIAL, UL94V-0, COLOR BLACK.
- 3. CONTACTS MATL: PHOS BRONZE ALLOY ROUND WIRE. SEE TABLE FOR PLATING.
- SHIELD MATL: PHOS BRONZE ALLOY, BRIGHT TIN PLATE OVER NICKEL UNDERPLATING PER BUS-15-002/M.
- 5. TWO LAYERS OF HIGH TEMP. INSULATING TAPE BETWEEN SHIELD AND SIGNAL CONTACTS.
- (6.) LF SUFFIX AT THE END OF PART NUMBER IS LEAD FREE.
- 7. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5mm MINIMUM THICK CIRCUIT BOARD. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.
- (8) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
- (9.) PLATING OPTIONS:
 MAY BE EITHER GOLD OR GXT PLATED AT MANUFACTURER'S OPTION.

mat'l. code —							tolerances unless otherwise specified						CUSTOMER				F	<u>C)</u>					
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1.27 [0.050] 6X

1.27 [0.050] 6X

1.270 [0.0500] 6.0089 [0.035] 8X

6.350 [0.2500]

6.350 [0.2500]

6.350 [0.062] 2X

EDGE OF PCB

1.270 [0.0500]

60.89 [0.035] 8X

61.57 [0.062] 2X

11.43 [0.450]

2.03 [0.080]

6

8

2,3,4,5,6,7

ALL POS

8.89 [0.350]

RECOMMENDED P.C.B. LAYOUT

AS VIEWED FROM TOP SIDE (COMPONENT SIDE)

1 2

ACAD PDM: Rev:M

cage code 4
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